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February 2017

RHRG1540CC, RHRG1560CC

30 A, 400 V - 600 V Hyperfast Dual Diode

Description

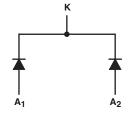
The RHRG1540CC, RHRG1560CC is a hyperfast dual diode with soft recovery characteristics. It has the half recovery time of ultrafast diodes and is silicon nitride passivated ionimplanted epitaxial planar construction. These devices are intended to be used as freewheeling/clamping diodes and diodes in a variety of switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

Ordering Information

PART NUMBER	PACKAGE	BRAND
RHRG1540CC	TO-247-3L	RHRG1540C
RHRG1560CC	TO-247-3L	RHRG1560C

NOTE: When ordering, use the entire part number.

Symbol



Features

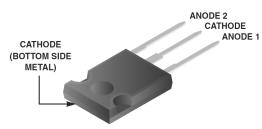
- Hyperfast Recovery t_{rr} = 40 ns (@ I_F = 15 A)
- Max Forward Voltage, $V_F = 2.1 \text{ V } (@ T_C = 25^{\circ}\text{C})$
- 400 V, 600 V Reverse Voltage and High Reliability
- · Avalanche Energy Rated
- RoHS Compliant

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

Packaging

JEDEC STYLE TO-247



Absolute Maximum Rating (Per Leg) T_C = 25°C, Unless Otherwise Specified

	RHRG1540CC	RHRG1560CC	UNITS	
Peak Repetitive Reverse Voltage	400	600	V	
Working Peak Reverse Voltage	400	600	V	
DC Blocking VoltageV _R	400	600	V	
Average Rectified Forward Current	15	15	Α	
Repetitive Peak Surge Current	30	30	Α	
Nonrepetitive Peak Surge Current	200	200	Α	
Maximum Power Dissipation	100	100	W	
Avalanche Energy (See Figure 10 and 11)	20	20	mJ	
Operating and Storage Temperature	-65 to 175	-65 to 175	°C	

Electrical Specifications (Per Leg) $T_C = 25^{\circ}C$, Unless Otherwise Specified

SYMBOL	TEST CONDITION	RHRG1540CC			RHRG1560CC			
		MIN	TYP	MAX	MIN	TYP	MAX	UNIT
V _F	I _F = 15 A	-	-	2.1	-	-	2.1	V
	I _F = 15 A, T _C = 150 ^o C	-	-	1.7	-	-	1.7	V
I _R	V _R = 400 V	-	-	100	-	-	-	μА
	V _R = 600 V	-	-	-	-	-	100	μΑ
	V _R = 400 V, T _C = 150 ^o C	-	-	500	-	-	-	μА
	V _R = 600 V, T _C = 150 ^o C	-	-	-	-	-	500	μА
t _{rr}	$I_F = 1 \text{ A, } dI_F/dt = 100 \text{ A/}\mu\text{s}$	-	-	35	-	-	35	ns
	I _F = 15 A, dI _F /dt = 100 A/μs	-	-	40	-	-	40	ns
ta	I _F = 15 A, dI _F /dt = 100 A/μs	-	20	-	-	20	-	ns
t _b	$I_F = 15 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}$	-	15	-	-	15	-	ns
Q _{rr}	I _F = 15 A, dI _F /dt = 100 A/μs	-	40	-	-	40	-	nC
CJ	V _R = 10 V, I _F = 0 A	-	60	-	-	60	-	pF
$R_{\theta JC}$		-	-	1.5	-	-	1.5	°C/W

DEFINITIONS

 V_F = Instantaneous forward voltage (pw = 300 μ s, D = 2%).

I_R = Instantaneous reverse current.

 T_{rr} = Reverse recovery time (See Figure 9), summation of $t_a + t_b$.

 t_a = Time to reach peak reverse current (See Figure 9).

 t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 9).

 Q_{rr} = Reverse Recovery Charge.

C_J = Junction Capacitance.

 $R_{\theta JC}$ = Thermal resistance junction to case.

pw = pulse width.

D = duty cycle.

Typical Performance Curves

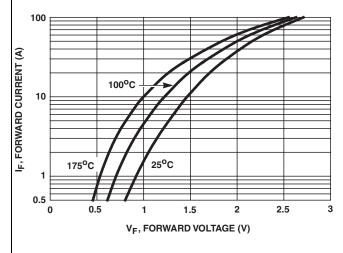


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

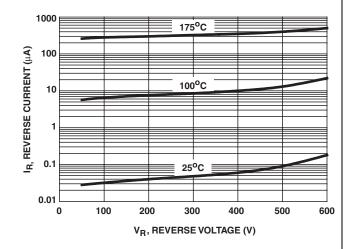


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

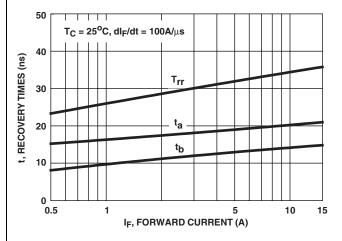


FIGURE 3. T_{rr} , t_a and t_b curves vs forward current

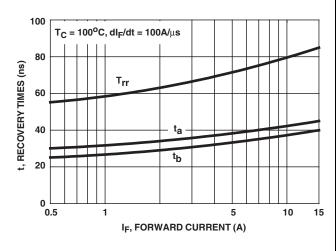


FIGURE 4. T_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

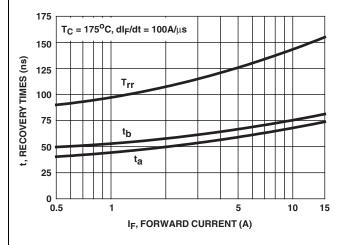


FIGURE 5. T_{rr} , t_a AND t_b CURVES vs FORWARD CURRENT

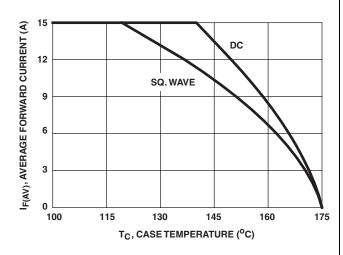


FIGURE 6. CURRENT DERATING CURVE

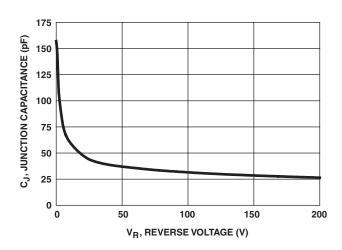


FIGURE 7. JUNCTION CAPACITANCE vs REVERSE VOLTAGE

Test Circuits and Waveforms

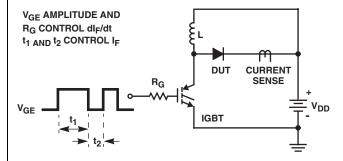


FIGURE 8. T_{rr} TEST CIRCUIT

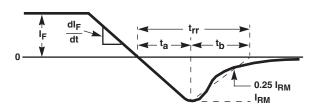


FIGURE 9. T_{rr} WAVEFORMS AND DEFINITIONS

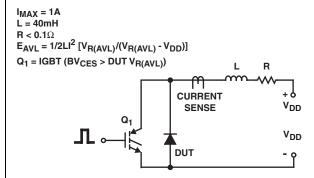


FIGURE 10. AVALANCHE ENERGY TEST CIRCUIT

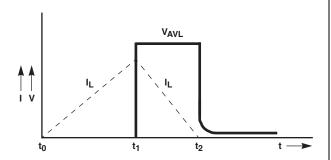
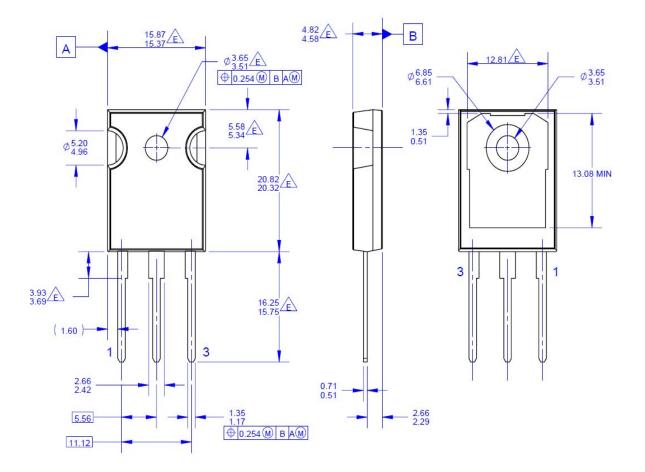


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

Package Dimensions



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. PACKAGE REFERENCE: JEDEC TO-247, ISSUE E, VARIATION AB, DATED JUNE, 2004.
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- ALL DIMENSIONS ARE IN MILLIMETERS.
- DRAWING CONFORMS TO ASME Y14.5 1994

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